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INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 7 : H01L 21/56

A1

(11) International Publication Number: **WO 00/02242**

(43) International Publication Date: 13 January 2000 (13.01.00)

(21) International Application Number: PCT/NL99/00424

(22) International Filing Date: 5 July 1999 (05.07.99)

(30) Priority Data:
1009563 6 July 1998 (06.07.98) NL

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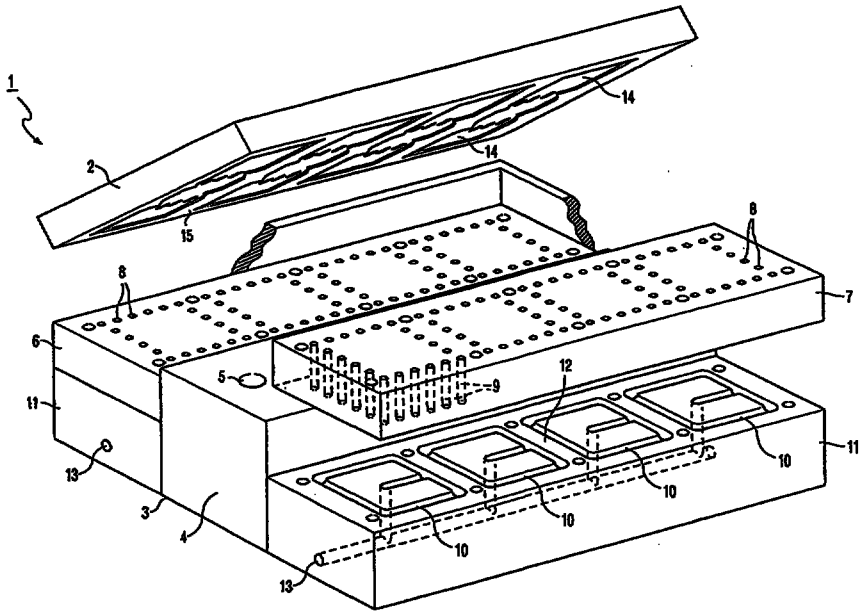
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(81) Designated States: JP, KR, SG, US, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

Published
With international search report.

(54) Title: MOULD, ENCAPSULATING DEVICE AND METHOD OF ENCAPSULATION



(57) Abstract

The invention relates to a mould for encapsulating electronic components mounted on a carrier, comprising: at least two mould parts displaceable relative to each other, at least one of which is provided with a recess, and feed means for encapsulating material, wherein at least one of the mould parts is provided with a runner which connects on one side to a wall of a mould part co–defining a mould cavity and connects on the other side to a side of the mould part remote from the mould cavity. The invention also relates to an encapsulating device of which such a mould forms part, and to a method for encapsulating electronic components mounted on a carrier.